NON-CATALOG

Low Pass Filter

LFCN-95

 50Ω

DC⁽¹⁾ to 95 MHz

Generic photo used for illustration purposes only

CASE STYLE: FV1206

Maximum Ratings

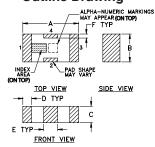
Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C
RF Power Input*	8.5W max. at 25°C

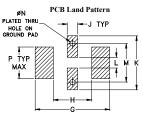
^{*} Passband rating, derate linearly to 3.5W at 100°C ambient Permanent damage may occur if any of these limits are exceeded.

Pin Connections

RF IN	1_
RF OUT	3
GROUND	2.4

Outline Drawing



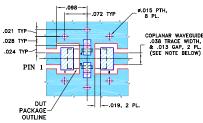


Suggested Layout, Tolerance to be within ±.002

Outline Dimensions (inch)

	G .169 4.29	F .009 0.23	.032 0.81	.020 0.51	C .037 0.94	B .063 1.60	A .126 3.20
wt	Р	N	М	L	K	J	Н
grams	.071	.012	.087	.024	.122	.024	.087
.020	1.80	0.30	2.21	0.61	3.10	0.61	2.21

Demo Board MCL P/N: TB-270 Suggested PCB Layout (PL-137)



COPLANAR WAYEGUIDE PARAMETERS ARE SHOWN FOR ROGERS ROA\$50B WITH THICKNESS .020" ± .0015". COPPER: 1/2 02. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED. NOTES: 1.

DENOTES DESCRIPTION OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Features

- excellent power handling, 8.5W
- small size
- 7 sections
- temperature stable
- LTCC construction
- protected by U.S. Patent 6,943,646

Applications

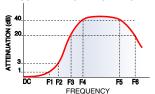
- harmonic rejection
- VHF/UHF transmitters/receivers

Electrical Specifications(1,2) at 25°C

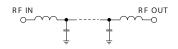
Parameter		F#	Frequency (MHz)	Min.	Тур.	Max.	Unit
Insertion Loss		DC-F1	DC-95	_	_	1.0	dB
Pass Band	ss Band Freq. Cut-Off		165	_	3.0	_	dB
	VSWR	DC-F1	DC-95	_	1.2	_	:1
			240	20	_	_	dB
Cton Bond	Rejection Loss	F4-F5	255-1600	_	40	_	dB
Stop Band		F6	4500	_	20	_	dB
	VSWR	F3-F6	240-4500	_	20	_	:1

- (1) In Application where DC voltage is present at either input or output ports, coupling capacitors are required.
- (2) Measured on Mini-Circuits Characterization Test Board TB-270.

Typical Frequency Response

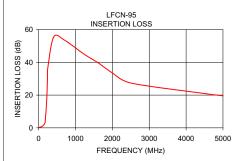


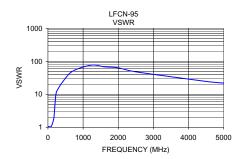
Electrical Schematic



Typical Performance Data at 25°C

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)
10.00	0.30	1.06
95.00	0.83	1.07
165.00	2.56	1.79
180.00	4.08	2.58
220.00	17.29	8.75
240.00	30.37	11.55
250.00	36.66	12.43
410.00	55.58	23.11
700.00	53.60	50.04
1235.00	44.98	76.58
1600.00	39.94	68.40
2000.00	33.54	63.70
2500.00	27.39	48.12
4500.00	20.96	24.63
5000.00	19.57	21.89





- Notes
 A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

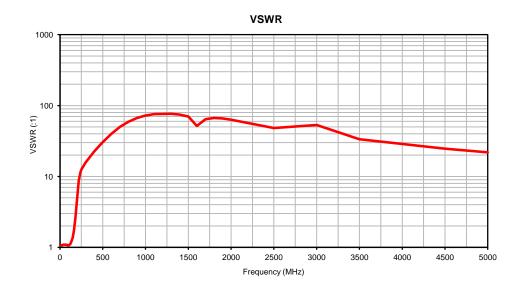
Typical Performance Data

FREQUENCY	INSERTION LOSS	VSWR
(MHz)	(dB)	(:1)
10.0	0.30	1.06
20.0	0.36	1.07
30.0	0.42	1.08
40.0	0.47	1.09
50.0	0.53	1.09
60.0	0.58	1.09
70.0	0.65	1.09
80.0	0.72	1.09
90.0	0.79	1.08
95.0	0.79	1.07
100.0	0.88	1.07
	1.11	1.11
120.0 140.0	1.11	1.11
150.0	1.48	1.26
160.0	2.24	1.40
		1.79
165.0	2.56	
170.0	2.95	2.00
180.0	4.08	2.58
190.0	5.84	3.51
200.0	8.49	4.92
220.0	17.29	8.75
240.0	30.37	11.55
250.0	36.66	12.43
255.0	38.46	12.80
300.0	35.46	15.77
400.0	51.79	22.42
500.0	45.51	30.48
600.0	46.98	39.72
700.0	53.60	50.04
800.0	61.99	58.95
900.0	55.63	66.98
1000.0	51.60	72.20 75.06
1100.0	48.44	75.96 76.17
1200.0	45.84	
1300.0	43.46	76.43
1400.0 1500.0	41.49	74.54
1600.0	40.06	70.08 51.50
	39.94	51.50
1700.0 1800.0	36.03 34.05	64.26 66.01
	34.95 34.15	66.91 66.02
1900.0	34.15	63.18
2000.0 2500.0		63.18 48.12
	27.39 26.23	
3000.0	26.23	53.14
3500.0	24.31	33.47
4500.0	20.96	24.63
5000.0	19.57	21.89



Typical Performance Curves



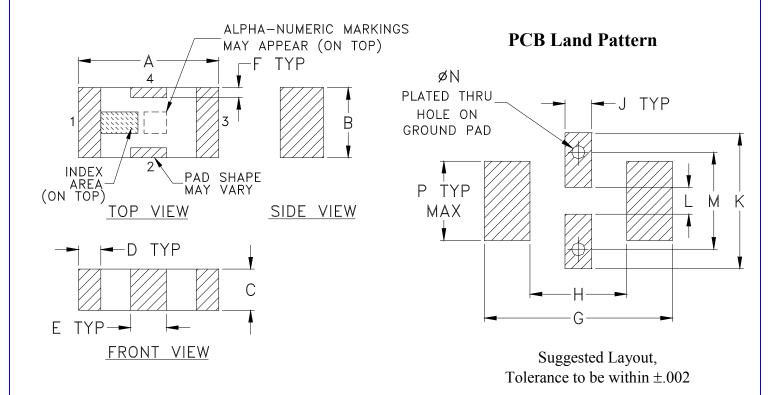


Case Style



FV1206

Outline Dimensions



CASE #	A	В	С	D	Е	F	G	Н	J	K	L	M	N	P	WT. GRAM
FV1206	.126 (3.20)	.063 (1.60)	.037 (0.94)	.020 (0.51)	.032 (0.81)	.009 (0.23)	.169 (4.29)	.087 (2.21)	.024 (0.61)	.122 (3.10)	.024 (0.61)	.087 (2.21)	.012 (0.30)	.071 (1.80)	.020

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

- 1. Open style, ceramic base.
- 2. Termination finish: as shown below or indicated on Data Sheet.

Tin plate over Nickel plate. All models, (+) suffix. For RoHS Case Styles:

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.





P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F71

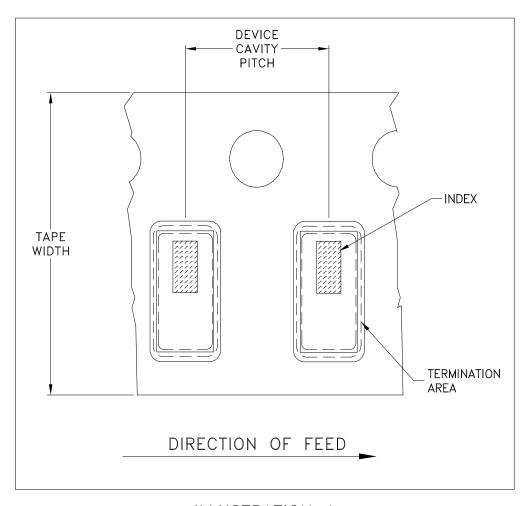


ILLUSTRATION 1

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices p	er Reel
				20
			Small	50
			quantity	100
8	4	7	standards	200
			(see note)	500
				1000
			Standard	3000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf





P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

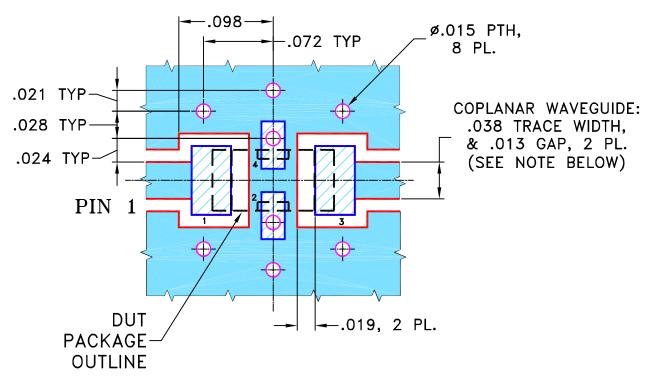
The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

THIRD ANGLE PROJECTION

PLE PROJECTION
-[

		REVISIONS			
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M88634	NEW RELEASE	08/28/03	GF	ABD
A	M102713	ADDED "WITH SMOBC"	01/17/06	MMG	IL

SUGGESTED MOUNTING CONFIGURATION FOR FV1206 CASE STYLE, "nx" PIN CONNECTION



NOTES: 1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH THICKNESS .020" ± .0015".

COPPER: 1/2 OZ. EACH SIDE.

FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



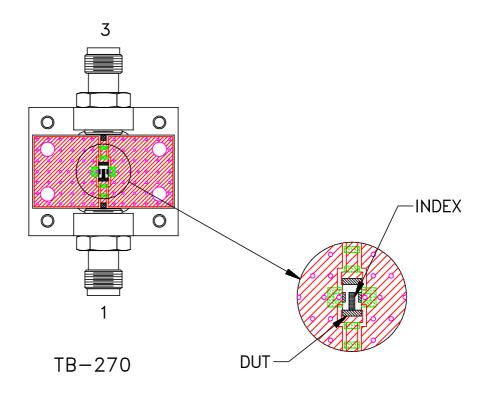
DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

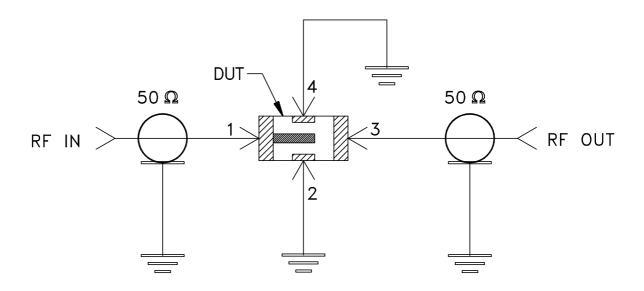


DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED)	INITIALS	DATE				. ~	•	• 4 (R)			
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TOLERANCES ON:	CHECKED	AV	08/28/03							БГООКІУП	NI IIA	
3 PL DECIMALS ± .005	APPROVED	ABD	08/28/03									
FRACTIONS ±				PL.	nx.	FV	1206	, LFCN	/HFC	N. T	B-2	70 l
□ Mini	–Circuits 🕲]	,,			,,	,	.,		
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EXCEPT FOR USE EXPRESSLY GRANTE AND THE UNITED STATES GOVERNMEN				SIZE CODE IDENT DRAWING NO:						REV:		
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Evaluation Board and Circuit

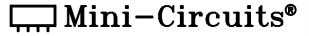




<u>Schematic Diagram</u>

Notes:

- 1. SMA Female connectors.
- 2. PCB Material: ROGERS RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.020 inch.





Environmental Specifications

ENV06

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A

ENV06 Rev: A

02/25/11

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